Low capacitance 7-fold bidirectional ESD protection diode arrays

Rev. 02 — 25 November 2004

Product data sheet

1. Product profile

1.1 General description

Low capacitance 7-fold bidirectional ESD protection diode arrays in small plastic packages designed for the protection of up to seven transmission or data lines from damage caused by ElectroStatic Discharge (ESD) and other transients.

Table 1: Product overview

Type number	Package								
	Name	Philips							
PESD5V0L7BAS	TSSOP8	SOT505-1							
PESD5V0L7BS	SO8	SOT96-1							

1.2 Features

- ESD protection of up to seven lines
- Low diode capacitance
- Max. peak pulse power: P_{pp} = 35 W
- Low clamping voltage: V_{(CL)R} = 17 V
- Ultra low leakage current: I_{RM} = 3 nA
- ESD protection of up to 10 kV
- IEC 61000-4-2, level 4 (ESD)
- IEC 61000-4-5 (surge); I_{pp} = 2.5 A.

1.3 Applications

- Computers and peripherals
- Communication systems
- Audio and video equipment
- High speed data lines
- Parallel ports.

1.4 Quick reference data

Table 2: Quick reference data

Symbol	Parameter	Conditions	Min	Тур Мах		Unit
V_{RWM}	reverse stand-off voltage		-	-	5	V
C _d	diode capacitance	$V_R = 0 V;$ f = 1 MHz	-	8	10	pF





2. Pinning information

Table 3: Pinning

Table 3:	Pinning		
Pin	Description	Simplified outline	Symbol
TSSOP8			
1	cathode 1		
2	cathode 2	8 5	1 8
3	cathode 3		2 7 7
4	cathode 4		
5	cathode 5		$\frac{3}{2}$ \bigcirc
6	cathode 6		4 1 5
7	cathode 7		
8	cathode 8	1 4	sym005
SO8			
1	cathode 1		
2	cathode 2	8	1 1 8
3	cathode 3		
4	cathode 4		
5	cathode 5		3 10 1 6
6	cathode 6		4 1 5
7	cathode 7	1	
8	cathode 8		sym005

3. Ordering information

Table 4: Ordering information

Type number	Package										
	Name	Description	Version								
PESD5V0L7BAS	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm	SOT505-1								
PESD5V0L7BS	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1								

4. Marking

Table 5: Marking codes

Type number	Marking code
PESD5V0L7BAS	5V0L7B
PESD5V0L7BS	5V0L7BS

5. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
P _{pp}	peak pulse power	8/20 μs pulse	<u>[1]</u> -	35	W
I _{pp}	peak pulse current	8/20 μs pulse	<u>[1]</u> _	2.5	А
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] Non-repetitive current pulse 8/20 μ s exponentially decaying waveform according to IEC61000-4-5; see Figure 1.

Table 7: ESD maximum ratings

Symbol	Parameter	Conditions	Min	Max	Unit
ESD	electrostatic discharge capability	IEC 61000-4-2 (contact discharge)	<u>[1]</u> -	10	kV
		HBM MIL-STD883	-	10	kV

^[1] Device stressed with ten non-repetitive ElectroStatic Discharge (ESD) pulses; see Figure 2.

Table 8: ESD standards compliance

ESD Standard	Conditions
IEC 61000-4-2, level 4 (ESD); see Figure 2	> 8 kV (contact)
HBM MIL-STD883, class 3	> 4 kV

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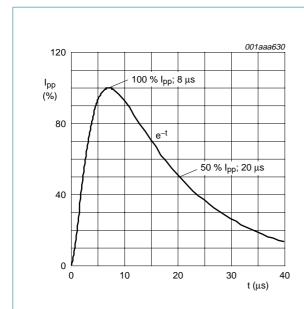


Fig 1. 8/20 μs pulse waveform according to IEC 61000-4-5.

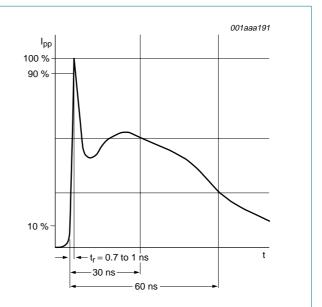


Fig 2. ElectroStatic Discharge (ESD) pulse waveform according to IEC 61000-4-2.





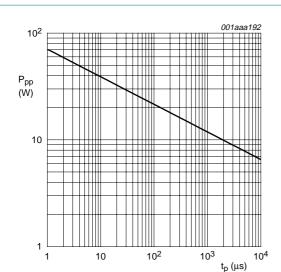
Table 9: Characteristics

 $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V_{RWM}	reverse stand-off voltage		-	-	5	V
I _{RM}	reverse leakage current	V _{RWM} = 5 V; see <u>Figure 6</u>	-	3	25	nA
V _{(CL)R}	clamping voltage	I _{pp} = 1 A	<u>[1]</u> _	-	11	V
		I _{pp} = 2.5 A	<u>[1]</u> _	-	17	V
$V_{(BR)}$	breakdown voltage	I _R = 1 mA	7.2	7.6	7.9	V
r _{dif}	differential resistance	I _R = 1 mA	-	-	100	Ω
C _d	diode capacitance	$V_R = 0 \text{ V; } f = 1 \text{ MHz;}$ see Figure 5	-	8	10	pF

 $^{[1] \}quad \text{Non-repetitive current pulse 8/20} \ \mu \text{s exponentially decaying waveform according to IEC61000-4-5; see } \underline{\text{Figure 1}}.$

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 $T_{amb} = 25 \, ^{\circ}C.$

Fig 3. Peak pulse power as a function of exponential pulse duration t_p; typical values.

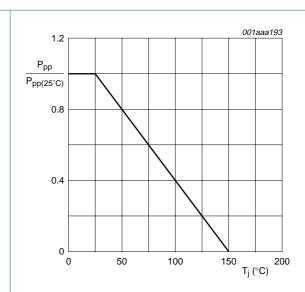
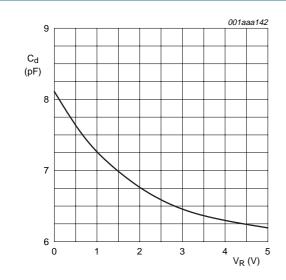


Fig 4. Relative variation of peak pulse power as a function of junction temperature; typical values.



 $T_{amb} = 25 \,^{\circ}\text{C}$; $f = 1 \, \text{MHz}$.

Fig 5. Diode capacitance as a function of reverse voltage; typical values.

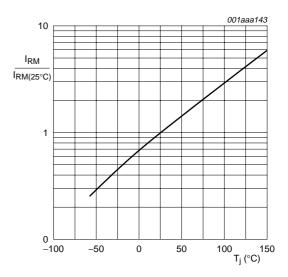
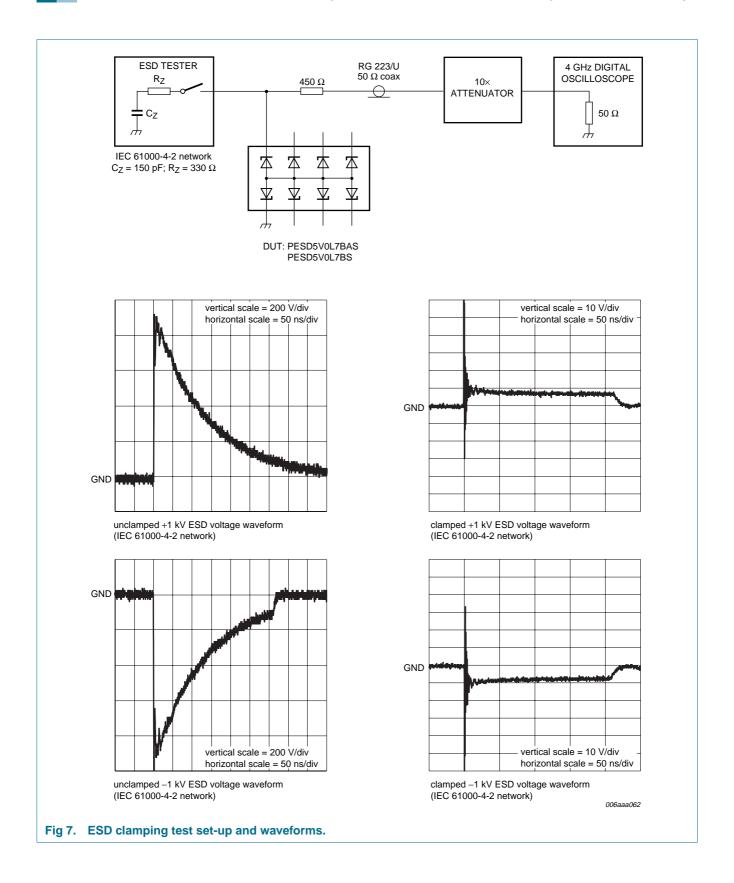


Fig 6. Relative variation of reverse leakage current as a function of junction temperature; typical values.

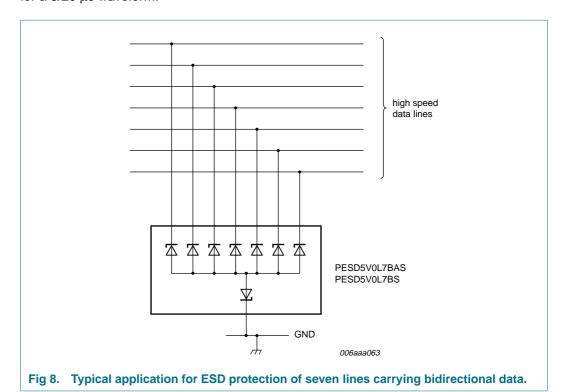
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7. Application information

The PESD5V0L7BAS and the PESD5V0L7BS are designed for protection of up to seven bidirectional data lines from the damage caused by ElectroStatic Discharge (ESD) and surge pulses. The PESD5V0L7BAS and the PESD5V0L7BS may be used on lines whose signal polarities are above and below ground.

The PESD5V0L7BAS and the PESD5V0L7BS provide a surge capability of 35 W per line for a $8/20~\mu s$ waveform.



Circuit board layout and protection device placement:

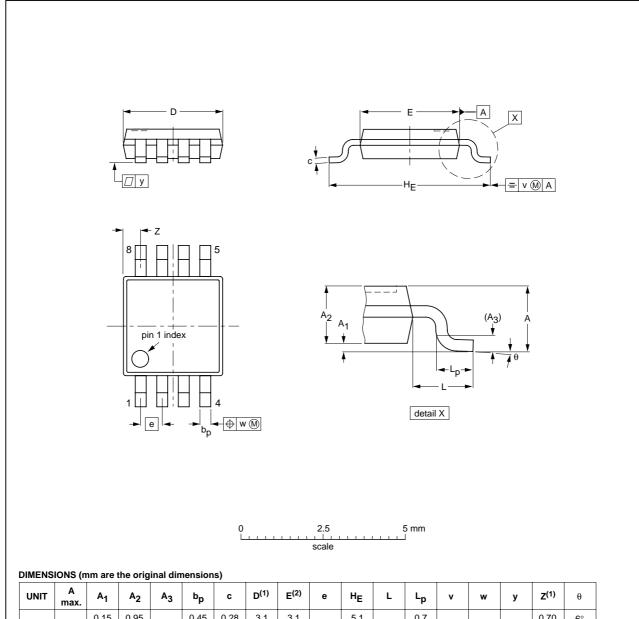
Circuit board layout is critical for the suppression of ESD, EFT and surge transients. The following guidelines are recommended:

- 1. Place the protection device as close as possible to the input terminal or connector.
- 2. Minimize the path length between the protection device and the protected line.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all printed-circuit board conductive loops including power and group loops.
- 6. Minimize the length of transient return paths to ground.
- 7. Avoid using shared return paths to a common ground point.
- 8. Ground planes should be used whenever possible.
- 9. Use vias for multilayer printed-circuit boards.

Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm

SOT505-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.45 0.25	0.28 0.15	3.1 2.9	3.1 2.9	0.65	5.1 4.7	0.94	0.7 0.4	0.1	0.1	0.1	0.70 0.35	6° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

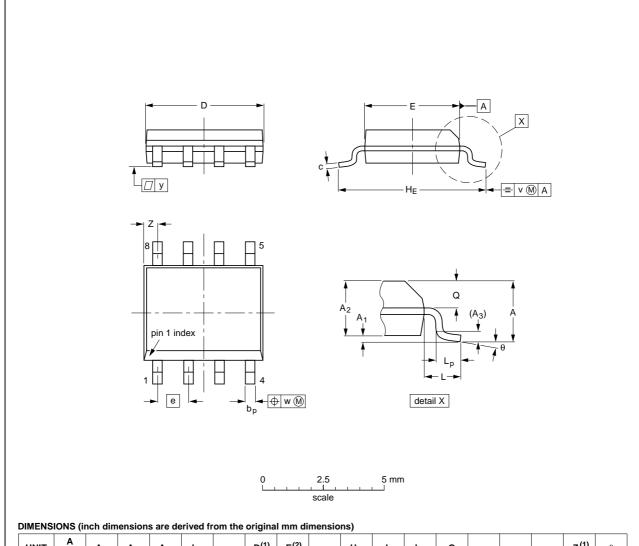
EDEC	JEITA	PROJECTION	ISSUE DATE		
	V	PROJECTION	ISSUE DATE		
			-99-04-09 03-02-18		

Fig 9. Package outline SOT505-1 (TSSOP8).

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SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	5.0 4.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014		0.20 0.19	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

	REFERENCES			EUROPEAN	ISSUE DATE	
SION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
96-1	076E03	MS-012				99-12-27 03-02-18
		IEC	IEC JEDEC	IEC JEDEC JEHA	IEC JEDEC JEHA	IEC JEDEC JEHA

Fig 10. Package outline SOT96-1 (SO8/MS-012).

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Table 10: Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [1]

Type number	Package	Description	Packing qu	Packing quantity	
			1000	2500	
PESD5V0L7BAS	SOT505-1	8 mm pitch, 12 mm tape and reel	·-	-118	
PESD5V0L7BS	SOT96-1	8 mm pitch, 12 mm tape and reel	-115	-118	

^[1] For further information and the availability of packing methods, see $\underline{\text{Section 14}}$.



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10. Revision history

Table 11: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
PESD5V0L7BAS_BS_2	20041125	Product data sheet	-	9397 750 13705	PESD5V0L7BS_1
 Modifications: The format of this data sheet has been redesign information standard of Philips Semiconductors. PESD5V0L7BAS added 			•	comply with the n	ew presentation and
	• <u>Table 1</u> : pr	oduct overview added			
	 Section 9 	Packing information add	ded		
PESD5V0L7BS_1	20040315	Product specification	-	9397 750 12249	-

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Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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- [3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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PESD5V0L7BAS; PESD5V0L7BS

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